

ENGINEERING

DEPT.

PRODUCT SPECIFICATION For CJ12 Series Board Mount Telephone Jacks

SPEC.NO.: SPCJ018A

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1. SCOPE:

This specification contains the test requirement of subject connectors when tested under the condition and below standards base on CviLux test procedure

2. APPLICABLE STANDARDS:

MIL - STD - 202Methods for test of connectors for electronic equipmentMIL - STD - 1344Test methods for electrical connectors

- 3. APPLICABLE SERIES NO.: CJ12 Series
- 4. SHAPE, CONSTRUCTION AND DIMENSIONS See attached drawings
- 5. MATERIALS See attached drawings
- 6. ACCOMMODATED P.C.BOARD6.1 Thickness: 1.6 mm (.063")6.2 P.C. Board Layout: See attached drawings



REVIEWED : <u>Alex</u> APPROVED : <u>David</u> VERIFIED : <u>Sandy</u>.



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7. ELECTRICAL PERFORMANCE:

| | ITEM | TEST CONDITION | REQUIREMENT |
|-----|---------------------------|---|--------------------------|
| 7.1 | Rated current and voltage | | 1.5A 125V AC (r.m.s.) |
| 7.2 | Contact resistance | Dry circuit of DC 20 mV max. 100 mA max. | Less than 20 m Ω |
| 7.3 | Dielectric strength | When applied AC 1000 V 1 minute between adjacent terminal | No change |
| 7.4 | Insulation resistance | When applied DC 500 V between adjacent terminal or ground | More than 500 M Ω |

8. MECHANICAL PERFORMANCE:

| | ITEM | TEST CONDITION | REQUIREMENT |
|-----|---|--|---|
| 8.1 | Mating force | Measure force to mate samples at speed 25±3mm per minute with plug latch depressed | 2.27 Kgf (5 lb) max. |
| 8.2 | Retention force (Between the jack and plug) | Retention speed 25±3mm per minute from jack | 7.7 Kgf (17 lb) min. |
| 8.3 | Durability | Connector shall be subjected to 300 cycles of insertion and withdrawal | Contact resistance: Less than twice of initial |

9. ENVIRONMENTAL PERFORMANCE:

| | ITEM | TEST CONDITION | REQUIREMENT |
|-----|------------------------------|---|--|
| 9.1 | Vibration | 1.5 mm 10 - 55 - 10 HZ/minute each 2 hours for X,Y and Z directions | Appearance: No damage Discontinuity: 1 micro second max. |
| 9.2 | Solder ability | Soldering time: 5±0.5 second Soldering pot: 230± 5°C | Minimum: 90% of immersed area |
| 9.3 | Resistance to soldering heat | Soldering time: 5±0.5 second Soldering pot: 260±5°C | No damage |
| 9.4 | Heat aging | 105±2°C, 96 hours | No damage |
| 9.5 | Humidity | 40±2°C, 90-95% RH, 96 hours measurement must be taken within 30 min. after tested | Appearance: No damage Contact resistance: Less than twice of initial Dielectric strength: To pass para 7-3 |



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| | ITEM | TEST CONDITION | REQUIREMENT |
|-----|---------------------|--|--|
| 9.6 | Temperature cycling | One cycle consists of : (1) $-55 {}^{+0}_{-3} \circ C$, 30 min. (2)Room temp. 10-15 min. (3) $85 {}^{+3}_{-0} \circ C$, 30 min. (4)Room temp. 10-15 min. | Appearance: No damage Contact resistance: Less than twice of initial |
| 9.7 | Salt spray | Temperature: 35±3°C Solution: 5±1% Spray time: 48±4 hours Measurement must be taken after water rinse | Appearance: No damage Contact resistance: Less than twice of initial |

10. AMBIENT TEMPERATURE RANGE: -40 to + 105°C